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A	2012-K Changes in respect to 2012-J DJV 26-07-2016 - changed ESD protection NUF2230 to PUSB3FR4, because of noise at cap sensor DJV 26-07-2016 - changed SHIELD plane on all layers DJV 26-07-2016 - added R20 and R21 between U3 and PUSB3FR4 DJV 26-07-2016 - added more GND vias on the edge of the GND planes 2012-J Changes in respect to 2012-I CDB 06-06-2016 - Removed copper under 0603 components	V0.8 Changes in respect to V0.7.1 CdB 25-09-2015 - Changed board shape CdB 25-09-2015 - Switched sides of PT100 and Heater for both hot-ends CdB 25-09-2015 - Added text for top and bottom CdB 25-09-2015 - Added ground planes to top and bottom CdB 25-09-2015 - Added test points to fan outputs	A
	2012-I Changes in respect to 2012-H CDB 27-05-2016 - Connected mechanical solder pins of J4, J7, J1 and J2 to GND for stronger connections CDB 25-05-2016 - Changed U7 to NUF2230 CDB 25-05-2016 - Removed C17 CDB 25-05-2016 - Changed D8 and D9 to ESD9L5.0ST5G CDB 25-05-2016 - Added D6 CDB 25-05-2016 - Added R19 (this resistor will or will not be placed) CDB 25-05-2016 - Added ESD_GND polygon for better ESD properties CDB 25-05-2016 - Made via's near U3 and ESD_GND bigger to lower impedance	V0.7.1 Changes in respect to V0.7 CdB 25-08-2015 - Increased via size on U3 V0.7 Changes in respect to V0.6 CdB 20-08-2015 - Changed fan and capacitive sensor connectors to SMD versions CdB 20-08-2015 - Re-did part of lay-out	B
C	2012-H Changes in respect to V0.9 CdB 26-02-2016 - Removed D6 and D7 CdB 26-02-2016 - Added U7, U8, C14 and C17 CdB 26-02-2016 - Added back of SP1 V0.9 Changes in respect to V0.8 CdB 08-11-2015 - Added TVS diodes D8 and D9 to 1-Wire lines	V0.6 Changes in respect to V0.5 CdB 20-08-2015 - Changed board shape CdB 20-08-2015 - Added SP1 CdB 20-08-2015 - Changed top connector to Molex 353631060 CdB 20-08-2015 - Completely re-did layout and routing CdB 20-08-2015 - Added test points V0.5 Changes in respect to V0.25 CdB 29-06-2015 - Changed board shape CdB 29-06-2015 - Completely re-did layout and routing CdB 29-06-2015 - Added i2c to 1 wire masters CdB 29-06-2015 - Changed JST connectors to spring loaded connectors CdB 29-06-2015 - Changed led driver to one with more outputs CdB 29-06-2015 - Added RGB leds	C
		V0.25 Changes in respect to V0.2: CdB 27-01-2015 - Removed solder mask between pads in fine pitch components CdB 27-01-2015 - Removed silk screen between fine pitch components CdB 27-01-2015 - Added tin thieves to connector J3 CdB 27-01-2015 - Added revision sheet CdB 27-01-2015 - Added tooling holes	D
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